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RoHS COMPLIANT

HALOGEN

FREE

GREEN



Vishay Semiconductors

High Power Infrared Emitting Diode, 940 nm, Surface Emitter Technology



DESCRIPTION

As part of the SurfLightTM portfolio, the VSMY99445DS is an infrared, 940 nm emitting diode based on surface emitter technology with high radiant power and high speed, molded in low thermal resistance SMD package with lens. A 42 mil chip provides outstanding radiant intensity and allows DC operation of the device up to 1 A. Superior ESD characteristics are ensured by an integrated Zener diode.

FEATURES

- Package type: surface mount
- Double stack technology
- Package form: high power SMD with lens
- Dimensions (L x W x H in mm): 3.85 x 3.85 x 2.24
- Peak wavelength: λ_p = 940 nm
- Zener diode for ESD protection up to 2 kV
- High radiant power
- · High radiant intensity
- Angle of half intensity: $\varphi = \pm 45^{\circ}$
- Designed for high drive currents: up to 1 A (DC) and up to 5 A pulses
- Low thermal resistance: R_{thJP} = 10 K/W
- Floor life: 168 h, MSL 3, acc. J-STD-020
- · Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Infrared illumination for CMOS cameras (CCTV)
- Illumination for cameras (3D gaming)
- Machine vision

PRODUCT SUMMARY					
COMPONENT	I _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)	
VSMY99445DS	500	± 45	940	15	

Note

· Test conditions see table "Basic Characteristics"

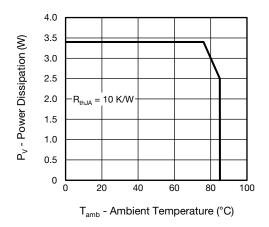
ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VSMY99445DS	Tape and reel	MOQ: 600 pcs, 600 pcs/reel	High power with lens		

Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		I _F	1	А	
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I _{FM}	2	Α	
Surge forward current	t _p = 100 μs	I _{FSM}	5	Α	
Power dissipation		P _V	3.4	W	
Junction temperature		T _j	110	°C	
Operating temperature range		T _{amb}	-40 to +85	°C	
Storage temperature range		T _{stg}	-55 to +100	°C	
Soldering temperature	According to fig. 10, J-STD-20	T _{sd}	260	°C	
Thermal resistance junction / pin	According to J-STD-051, soldered on PCB	R _{thJP}	10	K/W	







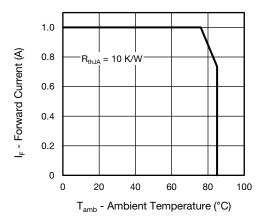


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 1 \text{ A}, t_p = 20 \text{ ms}$	V _F	-	2.9	3.4	V
	$I_F = 5 \text{ A}, t_p = 100 \mu \text{s}$	V_{F}	-	4.6	-	V
Temperature coefficient of V _F	I _F = 1 A	TK _{VF}	-	-2.5	-	mV/K
Reverse current	V _R = 5 V	I _R	Not designed for reverse operation			μΑ
Radiant intensity	$I_F = 1 \text{ A}, t_p = 20 \text{ ms}$	I _e	320	500	900	mW/sr
	$I_F = 5 \text{ A}, t_p = 100 \mu \text{s}$	I _e	-	2790	-	mW/sr
Radiant power	$I_F = 1 \text{ A}, t_p = 20 \text{ ms}$	фe	-	935	-	mW
Temperature coefficient of ϕ_{e}	I _F = 1 A	TKφ _e	-	-0.2	-	%/K
Angle of half intensity		φ	-	± 45	-	deg
Peak wavelength	I _F = 1 A	λ_{p}	920	940	960	nm
Spectral bandwidth	I _F = 1 A	Δλ	-	50	-	nm
Temperature coefficient of λ_p	I _F = 1 A	TKλ _p	-	0.3	-	nm/K
Rise time	I _F = 1 A	t _r	-	15	-	ns
Fall time	I _F = 1 A	t _f	-	18	-	ns



BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

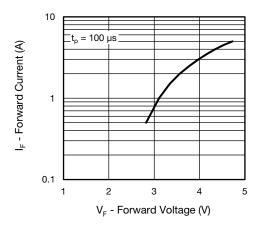


Fig. 3 - Forward Current vs. Forward Voltage

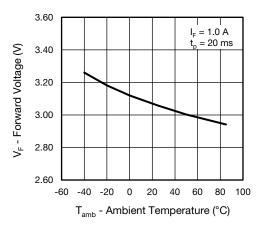


Fig. 4 - Forward Voltage vs. Ambient Temperature

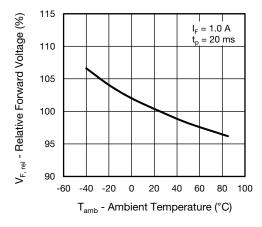


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

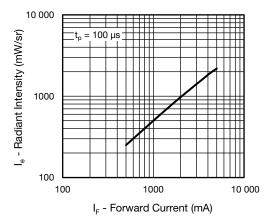


Fig. 6 - Radiant Intensity vs. Forward Current

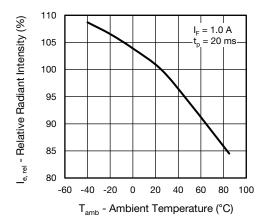


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

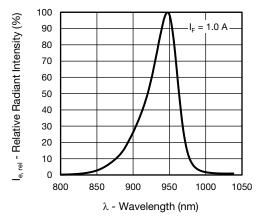


Fig. 8 - Relative Radiant Intensity vs. Wavelength

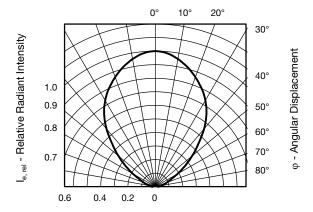
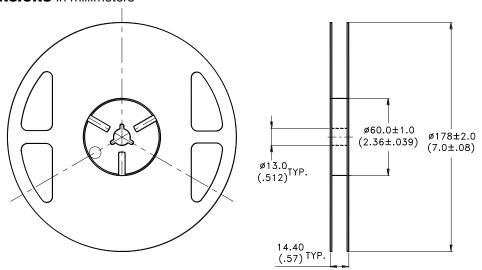


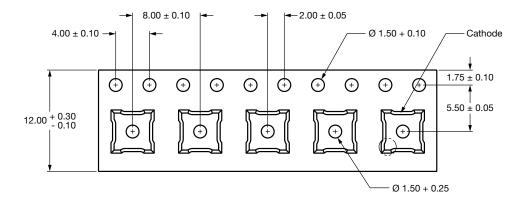
Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

TAPING DIMENSIONS in millimeters



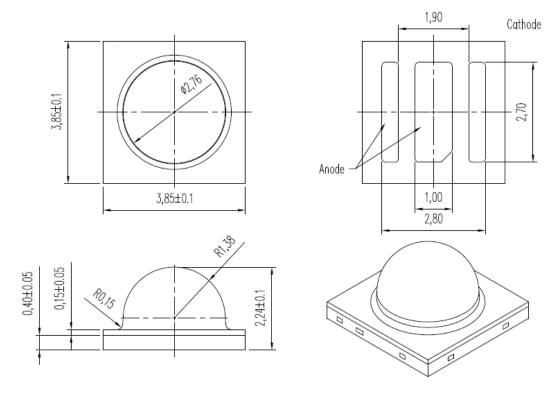
Notes

- Empty component pockets sealed with top cover tape.
- 7 inch reel 600 pieces per reel.
- The maximum number of consecutive missing lamps is two.
- In accordance with ANSI/EIA 481-1-A-1994 specifications.



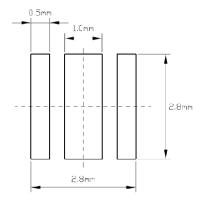


PACKAGE DIMENSIONS in millimeters



Notes

- Tolerance is ± 0.10 mm (0.004") unless otherwise noted.
- Specifications are subject to change without notice.



SOLDER PROFILE

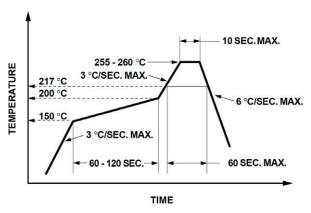


Fig. 10 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, acc. to J-STD-020B

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.



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Vishay

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